# E·XFL



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#### Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

#### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Details	
Product Status	Active
Number of LABs/CLBs	31775
Number of Logic Elements/Cells	406720
Total RAM Bits	29306880
Number of I/O	500
Number of Gates	-
Voltage - Supply	0.97V ~ 1.03V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 100°C (TJ)
Package / Case	900-BBGA, FCBGA
Supplier Device Package	900-FCBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc7k410t-3fbg900e

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

# MCH3914

# N-Channel JFET 15V, 16 to 50mA, 29mS, MCPH3

ON Semiconductor® http://onsemi.com

# **Features**

- | yfs | is large
- Ciss is small
- · Small package
- FBET process
- Halogen free compliance

# **Specifications**

# Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSX		15	V
Gate-to-Drain Voltage	VGDS		-15	V
Gate Current	IG		5	mA
Drain Current	ID		50	mA
Allowable Power Dissipation	PD	When mounted on ceramic substrate (600mm <sup>2</sup> ×0.8mm)	300	mW
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

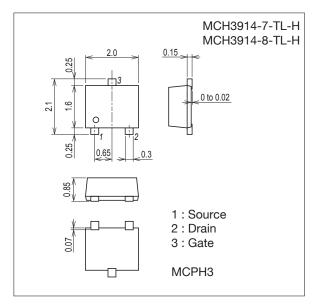
This product is designed to "ESD immunity < 200V\*", so please take care when handling.

\* Machine Model

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

# **Package Dimensions**

unit : mm (typ) 7019A-006



# **Product & Package Information**

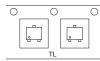
- : MCPH3
- JEITA, JEDEC

Package

- : SC-70, SOT-323
- Minimum Packing Quantity : 3,000 pcs./reel

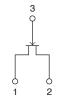
### Packing Type : TL







# **Electrical Connection**



#### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

# Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Gate-to-Drain Breakdown Voltage	V(BR)GDS	I <sub>G</sub> =-10μA, V <sub>DS</sub> =0V	-15			V
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =-10V, V <sub>DS</sub> =0V			-1.0	nA
Cutoff Voltage	V <sub>GS</sub> (off)	V <sub>DS</sub> =5V, I <sub>D</sub> =10μA	-0.6	-1.4	-3.0	V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =5V, V <sub>GS</sub> =0V	16.0*		50.0*	mA
Forward Transfer Admittance	yfs  1	V <sub>DS</sub> =5V, I <sub>D</sub> =10mA, f=1kHz	14	21		mS
	yfs  2	V <sub>DS</sub> =5V, V <sub>GS</sub> =0V, f=1kHz	14	29		mS
Input Capacitance	Ciss			4.9		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =5V, V <sub>GS</sub> =0V, f=1MHz		1.4		pF

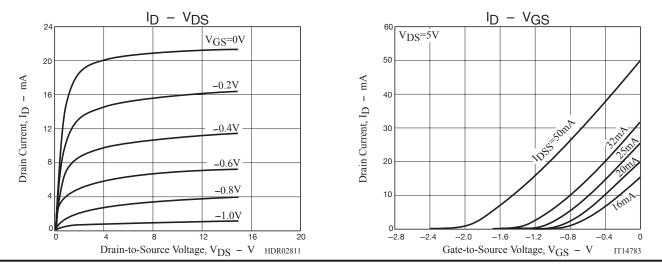
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

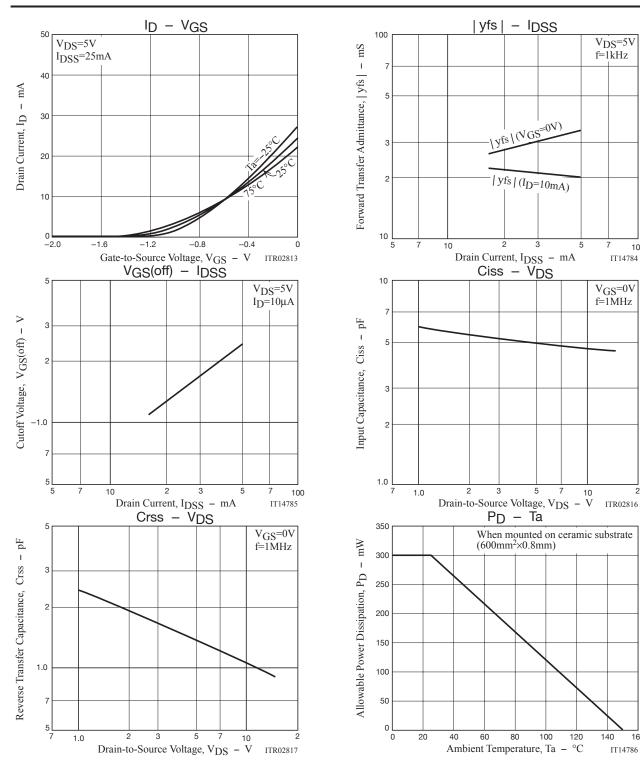
# $^{\star}$ : The MCH3914 is classified by IDSS as follows : (unit : mA)

Rank	7	8
IDSS	16.0 to 32.0	25.0 to 50.0

# **Ordering Information**

Device	Package	Shipping	memo
MCH3914-7-TL-H	MCPH3	3,000pcs./reel	Pb Free and Halogen Free
MCH3914-8-TL-H	MCPH3	3,000pcs./reel	Fb Free and Halogen Free





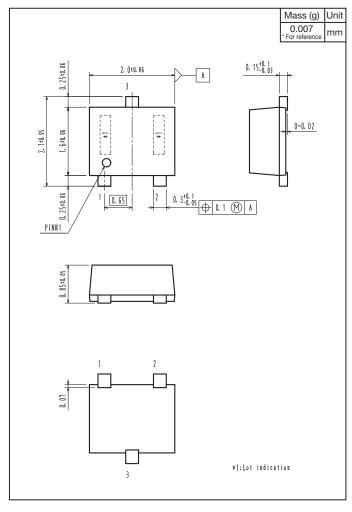
100

2

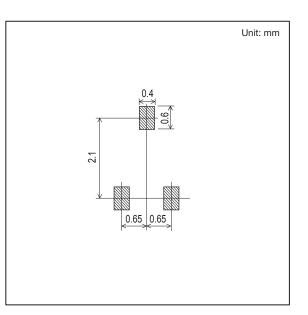
160

# Outline Drawing

MCH3914-7-TL-H, MCH3914-8-TL-H



### Land Pattern Example



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